

THE CONNOR-WINFIELD CORP.

2111 COMPREHENSIVE DRIVE. AURORA, IL 60505. FAX (630) 851-5040. PHONE (630) 851-4722. WWW.CONWIN.COM



PRODUCT DATA SHFFT

CRYSTAL CONTROLLED OSCILLATORS

SURFACE MOUNT 3.3V LVCMOS STRATUM 3 OCXO



ASOF3S3

DESCRIPTION

The Connor-Winfield ASOF3S3 is a true Surface Mount 3.3V Oven Controlled Crystal Oscillator (OCXO) with an LVCMOS output. The ASOF3S3 is designed for Stratum 3 applications requiring tight frequency stability and low jitter.

FEATURES

FIXED FREQUENCY OCXO

3.3V OPERATION

LOW JITTER <1pS RMS

FREQUENCY STABILITY: ±0.25ppm

TEMPERATURE RANGE: 0 to 70°C

FREQUENCY TOLERANCE OF ±4.6ppm **OVER TWENTY YEARS**

SURFACE MOUNT PACKAGE

TAPE AND REEL PACKAGING

RoHS 5/6 COMPLIANT

ORDERING INFORMATION

ASOF3S3 - 12.80MHz OCXO. CENTER SERIES FREQUENCY

ABSOLUTE MAXIMUM RATINGS

TABLE 1.0 PARAMETER MINIMUM UNITS NOMINAL MAXIMUM UNITS NOTE Storage Temperature 125 °C Supply Voltage (Vcc) -0.5 4.5 Vdc

OPERATING SPECIFIC ATIONS TABLE 2.0

PARAMETER		MINIMUM	NOMINAL	MAXIMUM	UNITS	NOTE
Center Frequency	(Fo)	1.544	-	20.0	MHz	
Frequency Calibration		-1.5		1.5	ppm	1,4
Frequency Stability		-0.25	-	0.25	ppm	2
Total Frequency Tolerance		-4.6	-	4.6	ppm	3
Aging (Daily		-30	-	30	ppb	4
Aging (20 years)		-3.0	-	3.0	ppm	
Operating Temperature Range		0	-	70	ပ္	
Supply Voltage	(Vcc)	3.135	3.3	3.465	Vdc	
Supply Current	(lcc)	-	-	450	mA	
Phase Jitter (BW =12KHz to 20MHz)		-	-	1	ps RMS	
Phase Jitter (BW =10Hz to 20MHz)		-	-	3	ps RMS	
Period Jitter		-	-	3	ps RMS	
Allan Variance (1 Second)		-	5.00 E-10	-		
SSB Phase Noise at 10Hz offset		-	-90	-	dBc/Hz	
SSB Phase Noise at 10KHz offset		-	-130	-	dBc/Hz	
Start-Up Time: Oscillator		-	-	10	mS	
Warm Up Time		-	-	5	Minutes	5
TDEV at 1.0 seconds		-	-	1	ns	
TDEV at 4.0 seconds		_	_	2	ns	

LVCMOS OUTPUT CHARACTERISTICS

TABLE 3.0 MINIMUM PARAMETER NOMINAL MAXIMUM UNITS NOTE LOAD pF 15 Voltage (High) (Voh) 2.6 Vdc (Low) (Vol) -0.4 Vdc -4 (High) (loh) Current mA (Low) (lol) 4 mΑ Duty Cycle at 50% of Vcc 45 50 55 % Rise / Fall Time 10% to 90% 6

PACKAGE CHARACTERISTICS

TABLE 4.0 Surface Mount, Non-hermetic package consisting of an FR4 substrate with Package grounded metal cover.

PROCESS RECOMMENDATIONS

TABLE 5.0

Soldering Process	See the solder profile on page 2.
Wash	Ultrasonic cleaning is not recommended

Notes:

- 1) Initial calibration @ 25 C
- Frequency vs. temperature stability
- Inclusive of calibration, operating temperature range, supply voltage change, shock and vibration and aging (20 years).
- Specifications at time of shipment after 48 hours of operation.
- Measured @ 25 C, within 5 minutes, the unit will be within +/-0.1ppm of its reference frequency, measured after 30 minutes of continuous operation at a stable 25 C.

Specifications subject to change without notice.



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PRODUCT DATA SHEET



CRYSTAL CONTROLLED OSCILLATORS

ENVIRONMENTAL CHARACTERISTICS

Temperature Cycle: Per MIL-STD-883, Method 1010, Condition B. -55°C to 125°C, 20 cycles,10 minute dwell, 1m inute transition.

SOLDERING

Pad Solderability: Per MIL-STD-883, Method 200. 8 hour steam age prior to 254°C ±5°C Solder pot dip, 95% Coverage. Solder Reflow: The component solder internal to this device has a melting point of 221°C, the peak temperature inside the device should be less than or equal to 220°C for a maximum of 10 seconds.

MECHANICAL CHARACTERISTICS

<u>Vibration</u>: Per MIL-STD-202, Method 204, Condition A. 10G's peak, 10Hz to 500Hz, 15mi nute cycles 12 times each perpendicular axis.

Shock: Per MIL-STD-202, Method 213, Condition D. 500G's, 1ms, half sine, 3 shocks per direction. Moisture Resistance: Per MIL-STD-202, Method 106. 95% RH @ 65°C, 10 cycles 10°C to 65°C.

Package Outline

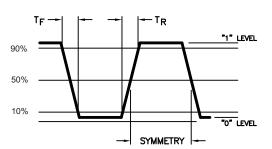
8 (13.84mm) 7 (1.71mm) (15.24mm) (1.71mm) (15.24mm)

Pin Connections

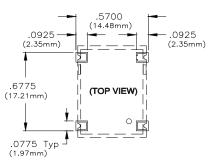
Pin	Function			
1	N/C			
7	Ground (Case)			
8	Output			
14	Vcc			

Dimensional Tolerance: ±.005 (.127mm)

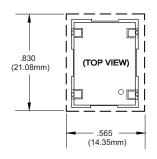
Output Waveform



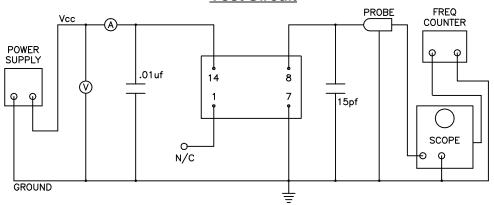
Suggested Pad Layout



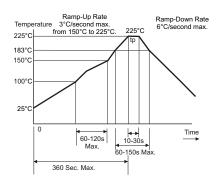
Keep Out Area



Test Circuit



Solder Profile



Specifications subject to change without notice.